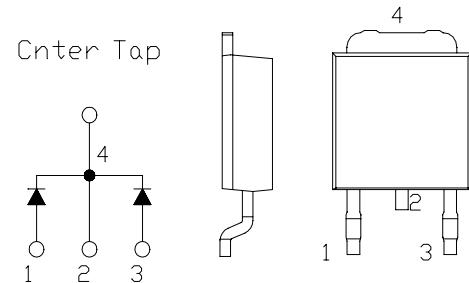


SBD Type : EA20QC09-F

OUTLINE DRAWING

FEATURES

- * TO-252AA Case, Surface Mount Device
- * Dual Diodes Cathode Common
- * Low Forward Voltage drop
- * Low Power Loss
- * High Surge Capability
- * 40 Volts thru 100 Volts Types Available
- * Packaged in 16mm Tape and Reel



Maximum Ratings

Approx Net Weight: 0.30g

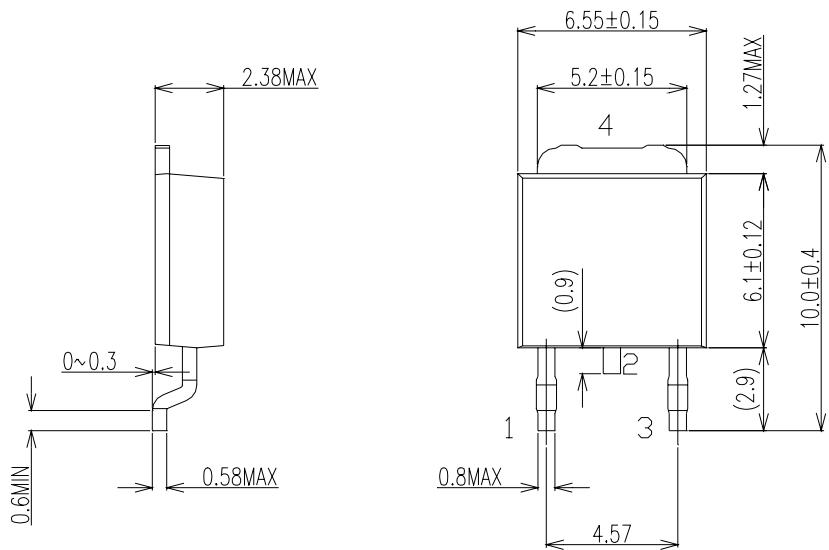
Rating	Symbol	EA20QC09-F				Unit			
Repetitive Peak Reverse Voltage	V _{RRM}	90				V			
Average Rectified Output Current	I _O	1.6	T _a =36°C	50Hz Full Sine Wave Resistive Load					
		2	T _c =138°C	A					
RMS Forward Current	I _{F(RMS)}	2.22				A			
Surge Forward Current	I _{FSM}	20	50Hz Full Sine Wave, 1cycle, Non-repetitive			A			
Operating Junction Temperature Range	T _{jw}	- 40 to + 150				°C			
Storage Temperature Range	T _{stg}	- 40 to + 150				°C			

Electrical • Thermal Characteristics

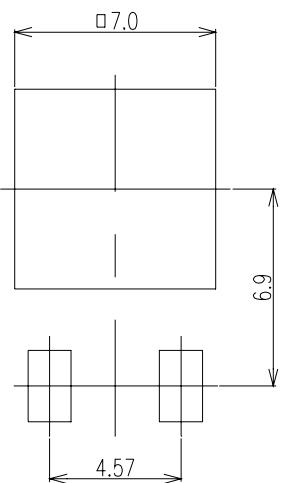
Characteristics		Symbol	Conditions	Min	Typ	Max	Unit
Peak Reverse Current		I _{RM}	T _j =25°C, V _{RRM} =V _{RM} per Arm	-	-	0.5	mA
Peak Forward Voltage		V _{FM}	T _j =25°C, I _{FM} = 1 A per Arm	-	-	0.58	V
Thermal Resistance	Junction to Ambient	R _{th(j-a)}	P.C. Board mounted *	-	-	80	°C/W
	Junction to Case	R _{th(j-c)}	-	-	-	6	°C/W

* Print Land = 20x20 mm

EA20QC09-F OUTLINE DRAWING (Dimensions in mm)



SOLDERING PAD



Center Tap

